



**THE DATASHEET OF
SS210LHR3G**



2A, 20V - 150V Schottky Barrier Surface Mount Rectifier

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

MECHANICAL DATA

- Case: Sub SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.019g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	2	A
V_{RRM}	20 - 150	V
I_{FSM}	50	A
T_{JMAX}	125, 150	°C
Package	Sub SMA	
Configuration	Single die	



Sub SMA



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)											
PARAMETER	SYMBOL	SS 22L	SS 23L	SS 24L	SS 25L	SS 26L	SS 29L	SS 210L	SS 215L	UNIT	
Marking code on the device		22L	23L	24L	25L	26L	29L	20L	2AL		
Repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	90	100	150	V	
Reverse voltage, total rms value	$V_{R(RMS)}$	14	21	28	35	42	63	70	105	V	
Forward current	I_F	2								A	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	50								A	
Critical rate of rise of off-state voltage	dv/dt	10,000								V/ μs	
Junction temperature	T_J	- 55 to +125			- 55 to +150					°C	
Storage temperature	T_{STG}	- 55 to +150									°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	17	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	75	°C/W

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	SS22L SS23L SS24L	$I_F = 2\text{A}, T_J = 25^\circ\text{C}$	V_F	-	0.50	V
	SS25L SS26L			-	0.70	V
	SS29L SS210L			-	0.85	V
	SS215L			-	0.95	V
Reverse current @ rated V_R ⁽²⁾	SS22L SS23L SS24L SS25L SS26L	$T_J = 25^\circ\text{C}$	I_R	-	400	μA
	SS29L SS210L SS215L			-	100	μA
	SS22L SS23L SS24L	$T_J = 100^\circ\text{C}$		-	15	mA
	SS25L SS26L			-	10	mA
	SS29L SS210L SS215L			-	-	mA
	SS22L SS23L SS24L	$T_J = 125^\circ\text{C}$		-	-	mA
	SS25L SS26L			-	-	mA
	SS29L SS210L SS215L			-	5	mA

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION		
ORDERING CODE⁽¹⁾	PACKAGE	PACKING
SS2xL	Sub SMA	10,000 / Tape & Reel

Notes:

1. "x" defines voltage from 20V(SS22L) to 150V(SS215L)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

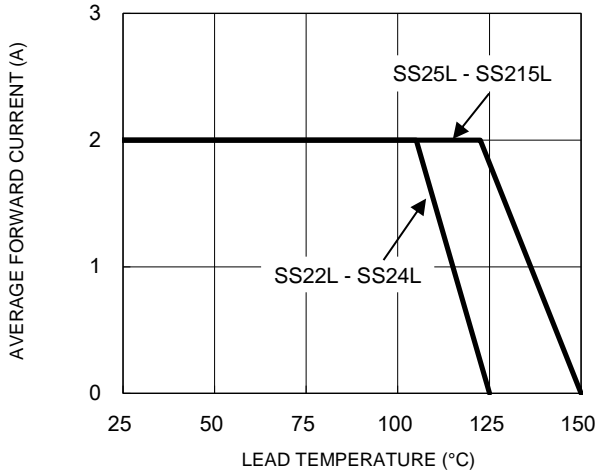


Fig.2 Typical Junction Capacitance

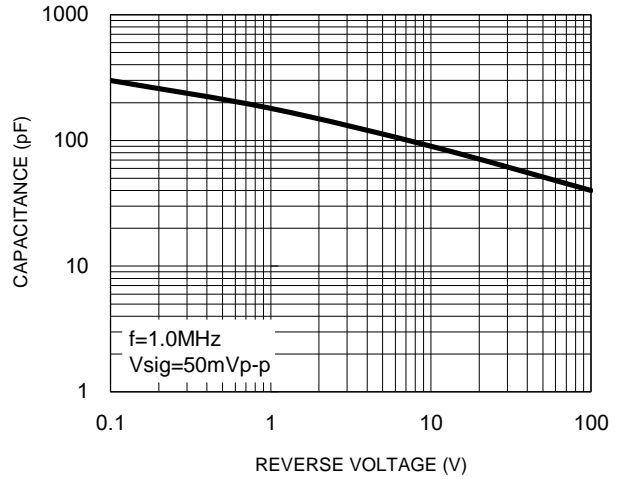


Fig.3 Typical Reverse Characteristics

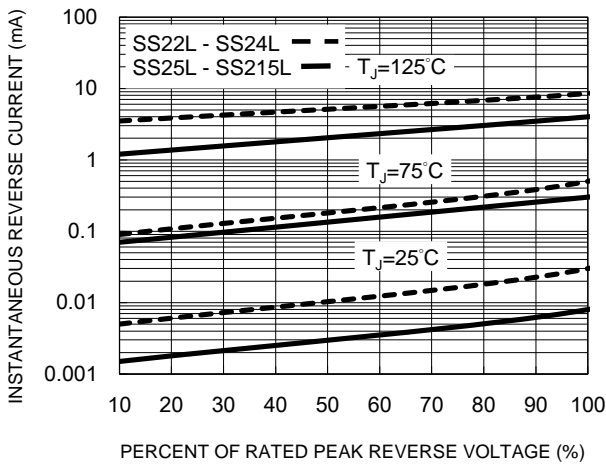


Fig.4 Typical Forward Characteristics

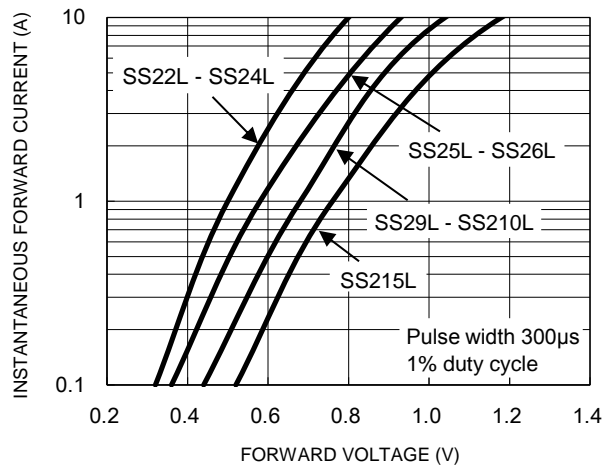
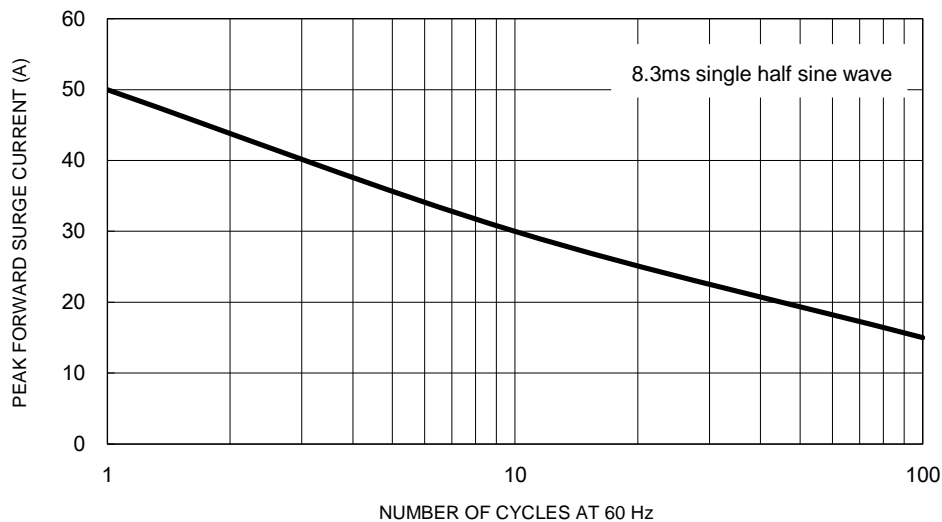


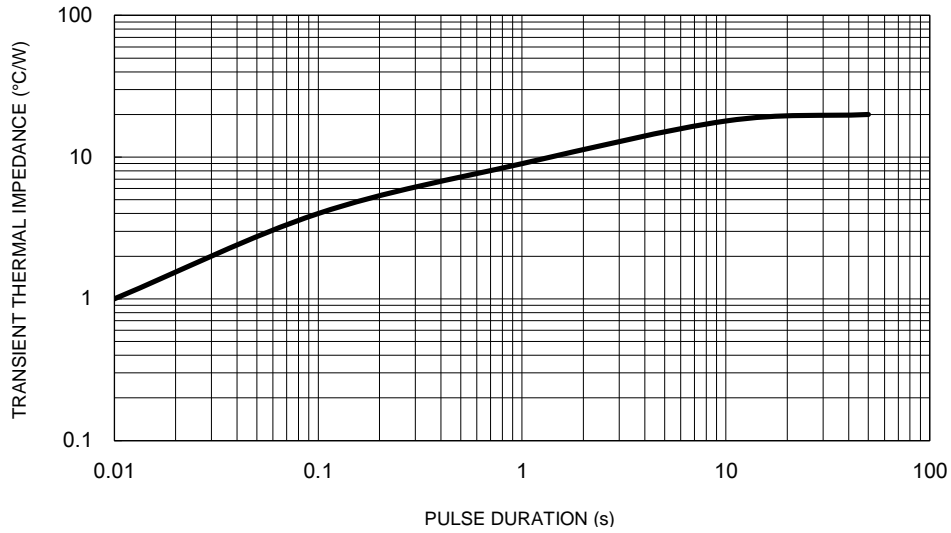
Fig.5 Maximum Non-Repetitive Forward Surge Current



CHARACTERISTICS CURVES

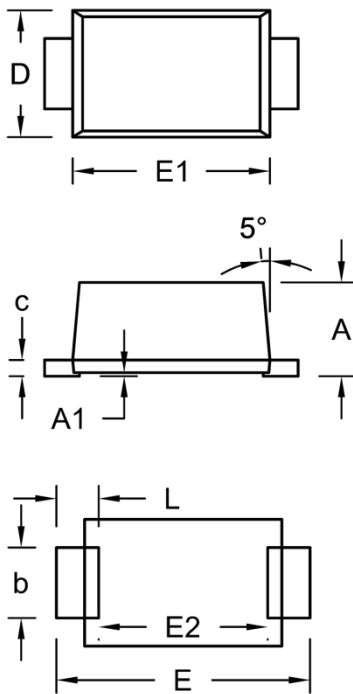
($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.6 Typical Transient Thermal Impedance



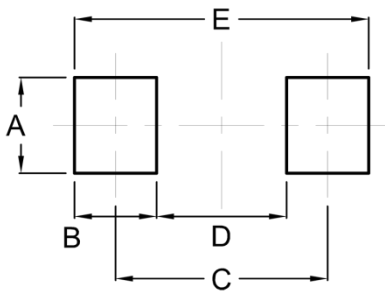
PACKAGE OUTLINE DIMENSIONS

Sub SMA



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	1.23	1.43	0.048	0.056
A1	0.00	0.10	0.000	0.004
b	0.80	1.20	0.031	0.047
C	0.16	0.30	0.006	0.012
D	1.70	1.90	0.067	0.075
E	3.40	3.80	0.134	0.150
E1	2.70	2.90	0.106	0.114
E2	2.45	2.60	0.096	0.102
L	0.35	0.85	0.014	0.033

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.40	0.055
B	1.20	0.047
C	3.10	0.122
D	1.90	0.075
E	4.30	0.169

MARKING DIAGRAM



- P/N = Marking Code
- G = Green Compound
- YW = Date Code
- F = Factory Code

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